

11-29-1999



To the Honorable Commissioner of

1. Name of conveying party(ies).

Hisashi TAKEUCHI, Takayoshi TAKAHARA and
Yasunobu SAKAI

Additional name(s) of conveying party(ies) attached? No

3. Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

Execution Date: February 18, 1999

e attached original documents or copy thereof.
e and address of receiving party(ies):

Name: Omron Corporation

Internal Address:

Street Address: 10 Tsuchido-cho, Hanazono, Ukyo-ku,
Kyoto,

City: Kyoto-shi, State: Japan ZIP:

Additional name(s) & address(es) attached? No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: February 18, 1999

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: William T. Ellis

Internal Address: FOLEY & LARDNER

Street Address: 3000 K Street, N.W., Suite 500

City: Washington, State: D.C. ZIP: 20007-5109

6. Total number of applications and patents involved: 1

7. Total fee (37 C.F.R. § 3.41). \$40.00

☒ Enclosed

☐ Authorized to be charged to deposit account

8. Deposit account number: 19-0741

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

William T. Ellis

Name of Person Signing

Signature

March 2, 1999

Date

Total number of pages including cover sheet, attachments, and document: 3

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

ATTORNEY DOCKET NO.

ASSIGNMENT

Application No. _____

Filed _____

Insert Name(s) of Inventor(s) ➡ WHEREAS, Hisashi TAKEUCHI, Takayoshi TAKAHARA and Yasunobu SAKAI

Insert Title of Invention ➡ Operation Integrated Control Method and Control Unit Therefor

(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in _____

for which an application for Letters Patent of the United States of America has been executed by the undersigned under 35 U.S.C. 371 resulting from the International Application No. PCT/JP97/03084; filed September 3, 1997,

Insert Date of Signing of Application ➡ on February 18, 1999; and

Insert Name of Assignee ➡ WHEREAS, OMRON CORPORATION

Insert Address of Assignee ➡ of 10, Tsuchido-cho, Hanazono, Ukyo-ku, Kyoto-shi, Kyoto, Japan

CHECK BOX IF APPROPRIATE ➡ ☒ its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and ☐ in any and all foreign countries.

NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries;

and to any and all divisions, reissues, continuations and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention of the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) the request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents of the United States of America resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of FOLEY & LARDNER, the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

Date February 18, 1999, Name of Inventor *Hisashi Takeuchi*
(signature) Hisashi TAKEUCHI

Date February 18, 1999, Name of Inventor *Takayoshi Takahara*
(signature) Takayoshi TAKAHARA

Date February 18, 1999, Name of Inventor *Yasunobu Sakai*
(signature) Yasunobu SAKAI

Date _____, Name of Inventor _____
(signature)

Date _____, Name of Inventor _____
(signature)

Date _____, Name of Inventor _____
(signature)

Date _____, Name of Inventor _____
(signature)

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(signature)

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(signature)

Date _____, Name of Inventor _____
(signature)

Date _____, Name of Inventor _____
(signature)